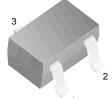


FJX733

Low Frequency Amplifier

- Collector-Base Voltage V_{CBO}= -60V
 Complement to FJX945



SOT-323

1. Base 2. Emitter 3. Collector

PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_a=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{CBO}	Collector-Base Voltage	-60	V
V _{CEO}	Collector-Emitter Voltage	-50	V
V _{EBO}	Emitter-Base Voltage	-5	V
I _C	Collector Current	-150	mA
P _C	Collector Power Dissipation	200	mW
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 ~ 150	°C

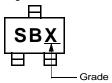
$\textbf{Electrical Characteristics} \ \, \textbf{T}_{a} \!\!=\!\! 25^{\circ} \textbf{C} \ \, \text{unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = -100, I _E =0	-60			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = -10mA. I _B =0	-50			V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E = -10. I _C =0	- 5			V
I _{CBO}	Collector Cut-off Current	V _{CB} = -25V, I _E =0			-100	nA
I _{EBO}	Emitter Cut-off Current	V_{EB} = -3V, I_{C} =0			-100	nA
h _{FE}	DC Current Gain	V_{CE} = -6V, I_{C} = -1mA	40		700	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -100mA, I _B = -10mA		-0.18	-0.3	V
V _{BE} (on)	Base-Emitter On Voltage	V_{CE} = -6V, I_{C} = -1mA	-0.50	-0.62	-0.80	V
f _T	Current Gain Bandwidth Product	V_{CE} = -6V, I_{C} = -10mA	50	180		MHz
C _{ob}	Output Capacitance	$V_{CB} = -10V, I_{E} = 0$ f=1MHz		2.8		pF
NF	Noise Figure	V _{CE} = -6V, I _C = -0.3mA f=1MHz, Rs=10K		6.0	20	dB

h_{FE} Classification

Classification	R	0	Y	G	L
h _{FE}	40 ~ 80	70 ~ 140	120 ~ 240	200 ~ 400	350 ~ 700





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Typical Characteristics

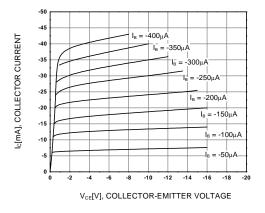


Figure 1. Static Characteristic

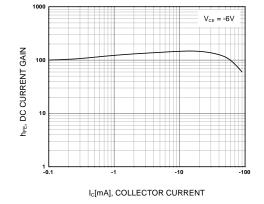


Figure 2. DC current Gain

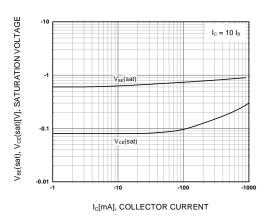


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

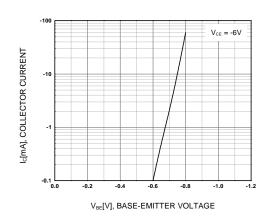


Figure 4. Base-Emitter On Voltage

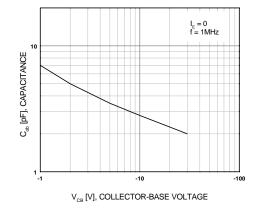


Figure 5. Collector Output Capacitance

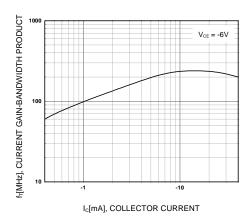
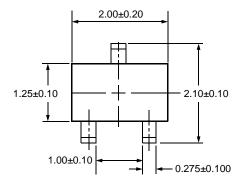


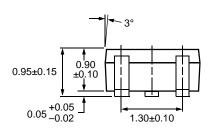
Figure 6. Current Gain Bandwidth Product

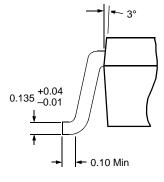
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Package Dimensions

SOT-323







Dimensions in Millimeters

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Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET [®]
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Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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